

# PRELIMINARY PRODUCT INFORMATION

GaAs INTEGRATED CIRCUIT

# **HIGH POWER DP4T SWITCH FOR WIMAX**

### DESCRIPTION

The uPG2181T5R is a GaAs MMIC high power DP4T switch which was developed for WiMAX.

This device can operate from 2.3GHz to 3.8GHz, with low insertion loss and high isolation.

This device is housed in a 20-pin RQFN(<u>Rectangle Quad Flat Non-Leaded</u>) package, and this is suitable for high-density surface mounting.

#### **FEATURES**

<ul> <li>Supply Voltage</li> </ul>	: V <sub>DD</sub> = 2.8 to 3.2V (3.0V TYP.)
Control Voltage	: $V_{\text{cont}}$ (H) = 1.5 to VDD (VDD TYP.)
	$: V_{cont} (L) = 0 \text{ to } 0.2V (0V TYP.)$
<ul> <li>Low Insertion Loss</li> </ul>	: Lins1 = 0.8dB TYP. @ f = 2.3 to 2.7GHz, VDD = 3.0V, Vcont (H) = 3.0V, Vcont (L) = 0V
	: Lins2 = 1.0dB TYP. @ f = 3.3 to 3.8GHz, VDD = 3.0V, Vcont (H) = 3.0V, Vcont (L) = 0V
<ul> <li>High Isolation</li> </ul>	: ISL1 = 28dB TYP.@ f = 2.3 to 2.7GHz, Tx to Rx, VDD = 3.0V, Vcont (H) = 3.0V, Vcont (L) = 0V
	: ISL2 = 24dB TYP.@ f = 3.3 to 3.8GHz, Tx to Rx, VDD = 3.0V, Vcont (H) = 3.0V, Vcont (L) = 0V
	: ISL3 = 25dB TYP.@ f = 2.3 to 2.7GHz, Tx to ANT, VDD = 3.0V, Vcont (H) = 3.0V, Vcont (L) = 0V
	: ISL4 = 21dB TYP.@ f = 3.3 to 3.8GHz, Tx to ANT, VDD = 3.0V, Vcont (H) = 3.0V, Vcont (L) = 0V
	: ISL5 = 25dB TYP.@ f = 2.3 to 2.7GHz, Rx to ANT, VDD = 3.0V, Vcont (H) = 3.0V, Vcont (L) = 0V
	: ISL6 = 22dB TYP.@ f = 3.3 to 3.8GHz, Rx to ANT, VDD = 3.0V, Vcont (H) = 3.0V, Vcont (L) = 0V
<ul> <li>Power Handling</li> </ul>	: Pin (1dB) = +40.0dBm TYP.@ f = 2.5/3.5GHz, Tx to ANT, VDD = 3.0V, Vcont (H) = 3.0V,
	$V_{\text{cont}}$ (L) = 0V
	: Pin (1dB) = +35.0dBm TYP.@ f = 2.5/3.5GHz, Rx to ANT, VDD = 3.0V, Vcont (H) = 3.0V,
	$V_{\text{cont}}$ (L) = 0V
<ul> <li>High-density surface mounting</li> </ul>	: 20-pin RQFN package(2.5 × 3.5 × 0.6 mm)

### APPLICATION

Antenna Switch for WiMAX CPE (Customer Premises Equipment)

### **ORDERING INFORMATION**

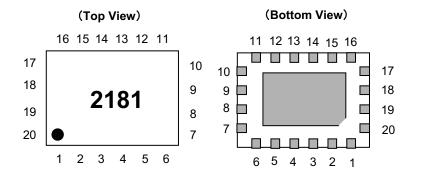
Part Number	Order Number	Package	Marking	Supplying Form
uPG2181T5R – E2	uPG2181T5R – E2 – A	20-pin plastic RQFN (Pb-Free)	2181	<ul> <li>Embossed tape 8 mm wide</li> <li>Pin1,6 face the perforation side of the tape</li> <li>Qty 3 kpcs/reel</li> </ul>

**Remark** To order evaluation samples, contact your nearby sales office. Part number for sample order : uPG2181T5R-A

#### Caution Electro-static sensitive devices

The information in this document is being issued in advance of the production cycle for device. The parameters for the device may change before final production or NEC Compound Semiconductor Devices, at its own discretion, may withdraw the device prior to its production.

### **PIN CONNECTIONS**



Pin NO.	Pin Name	Pin No.	Pin Name
1	GND	11	GND
2	GND	12	ANT1
3	Rx	13	GND
4	GND	14	Тх
5	ANT4	15	GND
6	GND	16	GND
7	ANT3	17	Vdd
8	GND	18	Vcont2
9	GND	19	Vcont1
10	ANT2	20	Vcont0

Exposed pad : GND

#### **TRUTH TABLE**

C	ONTROL	. VOLTAG	E	ON F			ON PATH				
					Т	Гх	Rx				
Vdd	Vcont0	Vcont1	Vcont2	ANT1	ANT2	ANT3	ANT4	ANT1	ANT2	ANT3	ANT4
High	Low	Low	Low	ON	OFF	OFF	OFF	OFF	OFF	OFF	OFF
High	High	Low	Low	OFF	ON	OFF	OFF	OFF	OFF	OFF	OFF
High	Low	High	Low	OFF	OFF	ON	OFF	OFF	OFF	OFF	OFF
High	High	High	Low	OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF
High	Low	Low	High	OFF	OFF	OFF	OFF	ON	OFF	OFF	OFF
High	High	Low	High	OFF	OFF	OFF	OFF	OFF	ON	OFF	OFF
High	Low	High	High	OFF	OFF	OFF	OFF	OFF	OFF	ON	OFF
High	High	High	High	OFF	OFF	OFF	OFF	OFF	OFF	OFF	ON

### ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	Vdd	4.2	V
Switch Control Voltage	Vcont	4.2	V
Input Power-Tx (ON Port)	Pin-Tx	+41	dBm
Input Power-Rx (ON Port)	Pin-Rx	+36	dBm
Input Power-Tx (OFF Port)	Pin-Tx (OFF)	+25	dBm
Input Power-Rx (OFF Port)	Pin-Rx (OFF)	+25	dBm
Power Dissipation	PD	800	mW
Operating Ambient Temperature	Та	-45 to +85	°C
Storage Temperature	Tstg	-55 to +150	٦°

### **RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)**

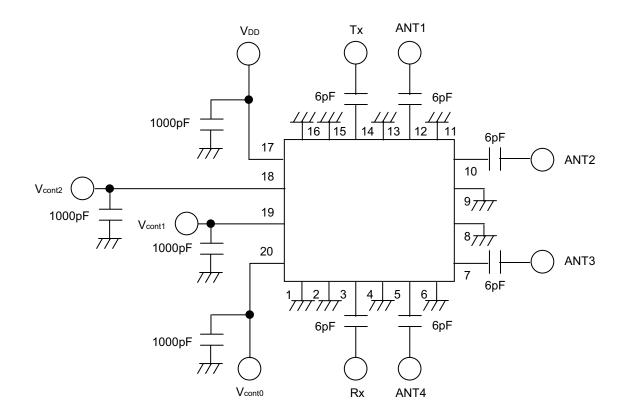
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	<b>f</b> opt1	2.3	-	2.7	GHz
	fopt2	3.3	-	3.8	GHz
Supply Voltage	Vdd	2.8	3.0	3.2	V
Switch Control Voltage (H)	Vcont (H)	1.5	Vdd	Vdd	V
Switch Control Voltage (L)	Vcont (L)	0	0	0.2	V

### ELECTRICAL CHARACTERISTICS

	•, •cont(L)		,	,		
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss1	Lins1	f = 2.3 to 2.7GHz, Tx to ANT1/2/3/4	-	0.80	1.05	dB
Insertion Loss2	Lins2	f = 3.3 to 3.8GHz, Tx to ANT1/2/3/4	-	1.00	1.30	dB
Insertion Loss3	Lins3	f = 2.3 to 2.7GHz, Rx to ANT1/2/3/4	-	0.80	1.05	dB
Insertion Loss4	Lins4	f = 3.3 to 3.8GHz, Rx to ANT1/2/3/4	-	1.00	1.30	dB
Isolation1	ISL1	f = 2.3 to 2.7GHz, Tx to Rx	25	28	-	dB
Isolation2	ISL2	f = 3.3 to 3.8GHz, Tx to Rx	21	24	-	dB
Isolation3	ISL3	f = 2.3 to 2.7GHz, Tx to ANT1/2/3/4	22	25	-	dB
Isolation4	ISL4	f = 3.3 to 3.8GHz, Tx to ANT1/2/3/4	18	21	-	dB
Isolation5	ISL5	f = 2.3 to 2.7GHz, Rx to ANT1/2/3/4	22	25	-	dB
Isolation6	ISL6	f = 3.3 to 3.8GHz, Rx to ANT1/2/3/4	19	22	-	dB
On Port Return Loss1	RLin1	f = 2.3 to 2.7GHz, All port	-	15	-	dB
On Port Return Loss2	RLin2	f = 3.3 to 3.8GHz, All port	-	15	-	dB
Unused Port Return Loss1	URLin1	f = 2.3 to 2.7GHz, Tx / Rx port	-	13	-	dB
Unused Port Return Loss2	URLin2	f = 3.3 to 3.8GHz, Tx / Rx port	-	13	-	dB
1dB Loss Compression	Pin(1dB)	f = 2.5GHz, Tx to ANT1/2/3/4	-	+40.0	-	dBm
Input Power <sup>Note</sup>		f = 3.5GHz, Tx to ANT1/2/3/4	-	+40.0	-	dBm
		f = 2.5GHz, Rx to ANT1/2/3/4	-	+35.0	-	dBm
		f = 3.5GHz, Rx to ANT1/2/3/4	-	+35.0	-	dBm
3rd Order Output	OIP3 1	f = 2.5GHz, Tx to ANT1/2/3/4	-	+63.0	-	dBm
Intercept Point	OIP3 2	f = 2.5GHz, Rx to ANT1/2/3/4	-	+57.0	-	dBm
Supply Current	loo	RF None	-	600	1100	uA
Switch Control Current	Icont	RF None	-	1	2	uA
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	250	-	ns

Note.  $P_{in(1dB)}$  is measured the input power level when the insertion loss increases more 1dB than that of linear range.

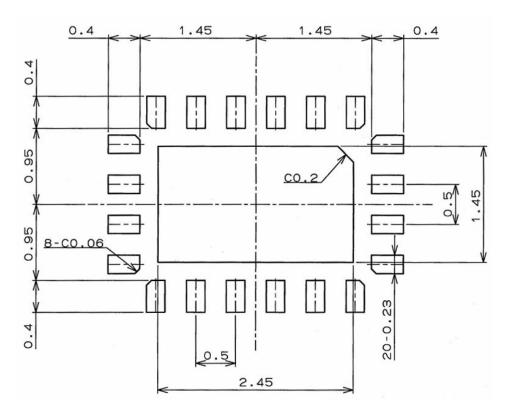
# **EVALUATION CIRCUIT**



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

### MOUNTING PAD DIMENSIONS

## 20-PIN PLASTIC RQFN (UNIT: mm)

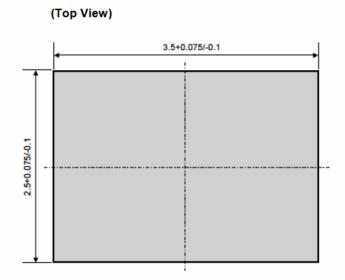


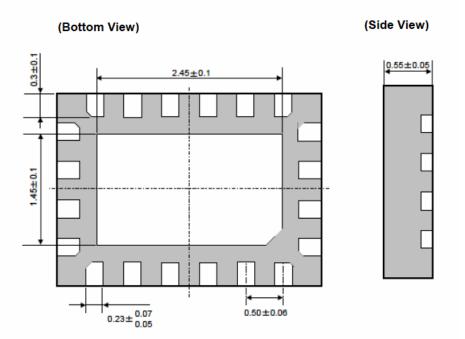
MOUNTING PAD

**Remark** The mounting pad layouts in this document are for reference only.

## PACKAGE DIMENSIONS

# 20-PIN PLASTIC RQFN (UNIT: mm)





### RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
РВВ	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

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